

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

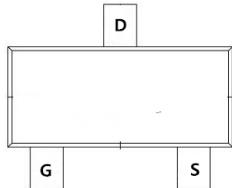
Applications

- Load switch
- PWM

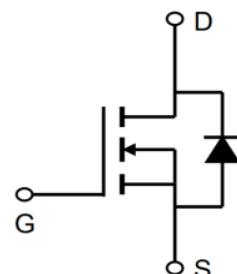
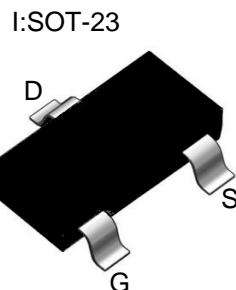
General Features

$V_{DS} = 100V$ $I_D = 4A$
 $R_{DS(ON)} = 120m\Omega$ (typ.) @ $V_{GS}=10V$

100% UIS Tested
 100% R_g Tested



Marking: 04N10



Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	V_{DS}	100	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current $T_A=25^\circ C$	I_D	4	A
$T_A=70^\circ C$		2.8	
Pulsed Drain Current ^A	I_{DM}	19	A
Total Power Dissipation @ $T_A=25^\circ C$	P_D	1.2	W
Thermal Resistance Junction-to-Ambient ^B	$R_{\theta JA}$	104	$^\circ C/W$
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^\circ C$

Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.0	1.8	3.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D =3.0A		120	140	mΩ
		V _{GS} = 4.5V, I _D =2.0A		150	180	
Diode Forward Voltage	V _{SD}	I _S =3.0A, V _{GS} =0V		0.8	1.2	V
Maximum Body-Diode Continuous Current	I _S				4.0	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V, f=1MHZ		206		pF
Output Capacitance	C _{oss}			29		
Reverse Transfer Capacitance	C _{rss}			1.4		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =50V, I _D =3.0A		4.3		nC
Gate-Source Charge	Q _{gs}			1.5		
Gate-Drain Charge	Q _{gd}			1.1		
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =50V, I _D =3.0A, R _{GEN} =2Ω		14.7		ns
Turn-on Rise Time	t _r			3.5		
Turn-off Delay Time	t _{D(off)}			20.9		
Turn-off fall Time	t _f			2.7		
Reverse recovery time	t _{rr}	I _S =3A, di/dt=100 A/ μ s		32		ns
Reverse recovery charge	Q _{rr}			39		nC
Peak reverse recovery current	I _{rm}			2.1		A

A. Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.

B. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

Typical Performance Characteristics

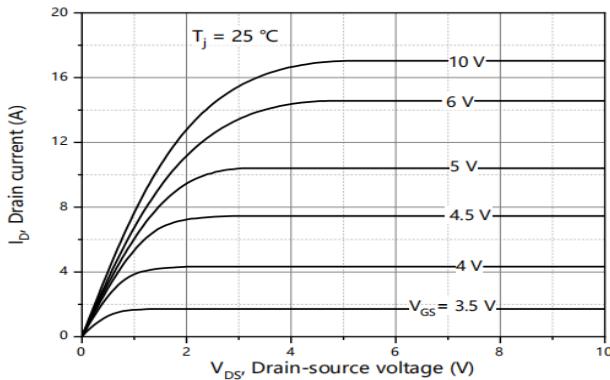


Figure1. Output Characteristics

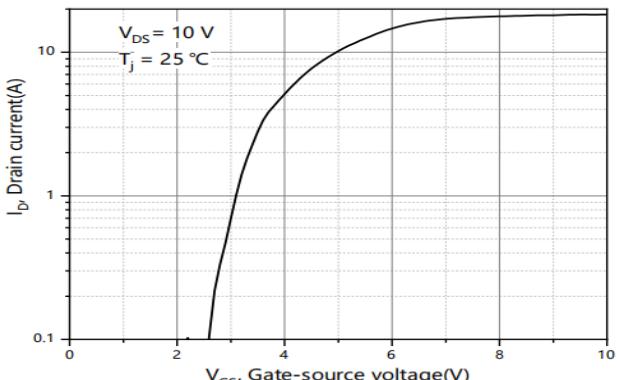


Figure2. Transfer Characteristics

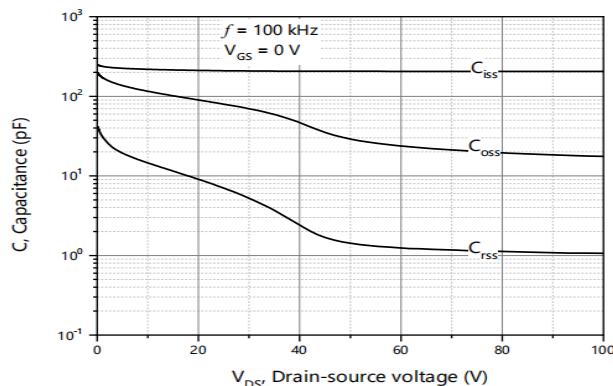


Figure3. Capacitance Characteristics

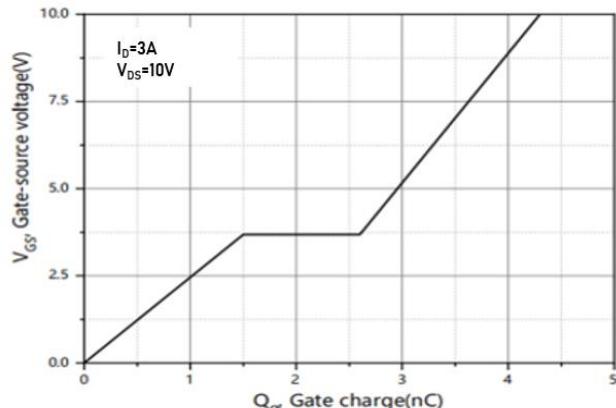


Figure4. Gate Charge

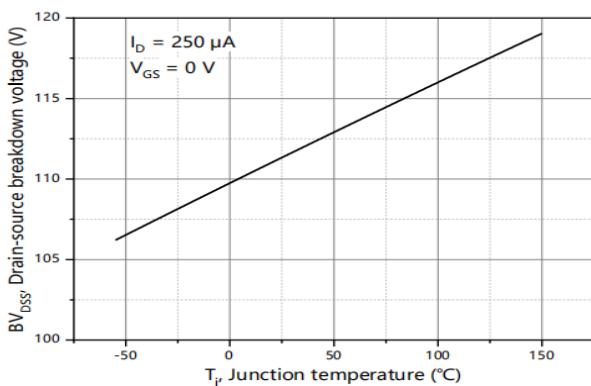


Figure5. Drain-Source breakdown voltage

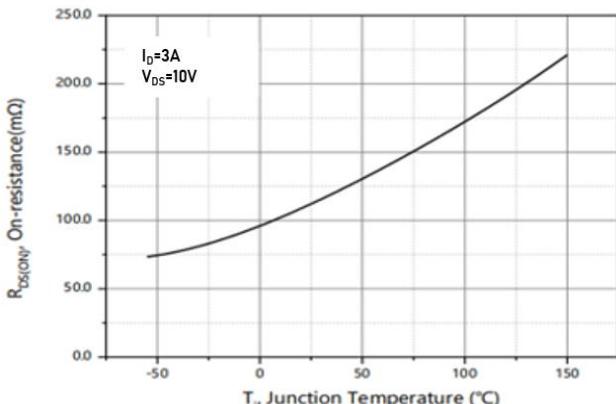


Figure6. Drain-Source on Resistance

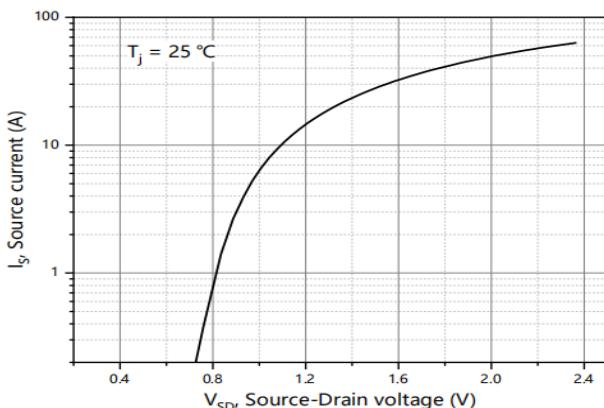


Figure7. Forward characteristic of body diode

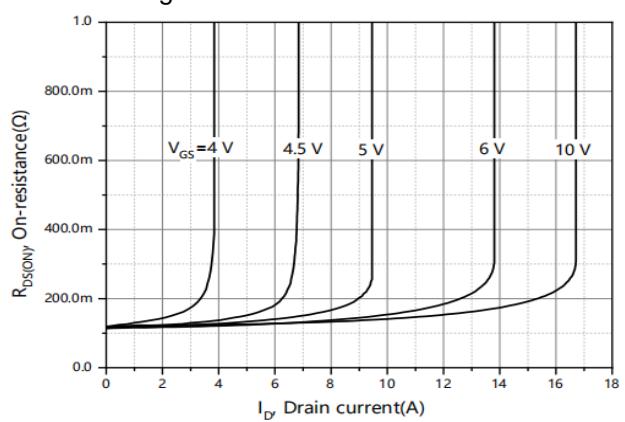


Figure8. Drain-source on-state resistance

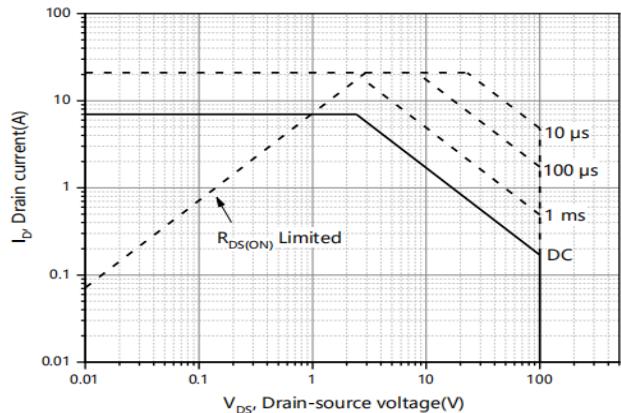


Figure9. Safe Operation Area $T_A=25\text{ }^{\circ}\text{C}$

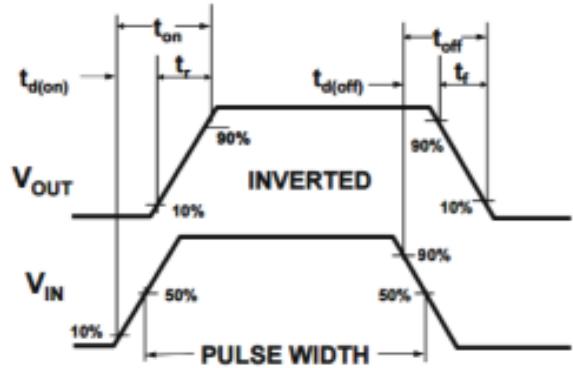
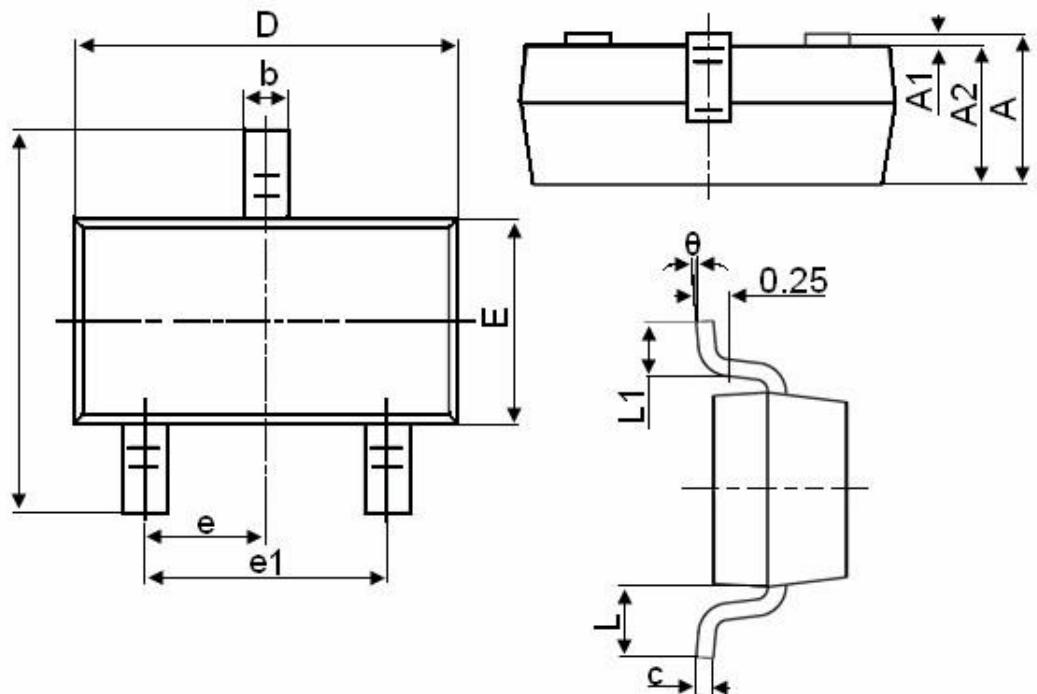


Figure10. Switching wave

Package Information SOT-23



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e		0.950TYP
e1	1.800	2.000
L		0.550REF
L1	0.300	0.500
θ	0°	8°